

Very High PSRR Low Noise 300mA RF LDO

DESCRIPTION

The SUM33XX family of low-dropout (LDO), low-power linear regulators offers very high power supply rejection ratio (PSRR) while maintaining very low 45 μ A ground current, suitable for RF applications. The family uses an advanced CMOS process and a PMOSFET pass device to achieve fast start-up, very low noise, excellent transient response, and excellent PSRR performance. The SUM33XX is stable with a 1.0 μ F ceramic output capacitor, and uses a precision voltage reference and feedback loop to achieve a worst-case accuracy of 2% over all load, line, process, and temperature variations. It is offered in a small UTDFN1.0×1.0-4 / DFN1.0×1.0-4 / SC70-5 / SOT23-3 / SOT23-5 packages, which are ideal for small form factor portable equipment such as wireless handsets and PDAs.

The SUM33XX is available in standard fixed output voltages of 0.8 V, 1.1 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V, 2.8 V, 3.0 V, 3.3 V, 3.6 V.

FEATURES

- Wide Input Voltage Range: 1.6 V to 6.0 V
- Up to 300 mA Load Current
- Standard Fixed Output Voltage Options: 0.8 V, 1.1 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V, 2.8 V, 3.0 V, 3.3 V and 3.6 V
- Other Output Voltage Options Available on Request
- Ultra Low Dropout: 250 mV at 300 mA Load
- Low Noise: 60 µV_{RMS} at 2.8 V output
- Ultra-Fast Start-Up Time: 25 μs
- Excellent Load/Line Transient Response
- Line Regulation: 0.03% typical
- With auto discharge function
- Package: UTDFN1.0×1.0-4; DFN1.0×1.0-4; SC70-5; SOT23-3; SOT23-5

APPLICATIONS

- Smart Phones and Cellular Phones
- PDAs

1

- MP3/MP4 Player
- Digital Still Cameras
- Portable instruments

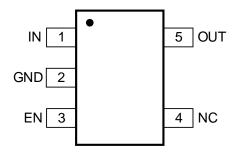


ORDER INFORMATION

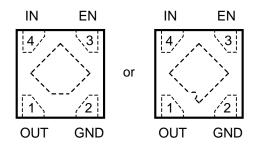
Model	Package	Ordering Number	Packing Option	Auto Discharge
	UTDFN1.0 × 1.0-4	SUM33XXUYB	Tape and Reel, 10000	With Auto Discharge
	DFN1.0 × 1.0-4	SUM33XXYB	Tape and Reel, 10000	With Auto Discharge
SUM33XX	SC70-5	SUM33XXSC	Tape and Reel, 3000	Without Auto Discharge
SUNISSAA	SC70-5	SUM33XXSCB	Tape and Reel, 3000	With Auto Discharge
	SOT23-3	SUM33XXKA3	Tape and Reel, 3000	With Auto Discharge
	SOT23-5	SUM33XX	Tape and Reel, 3000	With Auto Discharge

^{*}XX: When expressed as 18, the output voltage is 1.8 V; when expressed as 30 the output voltage is 3.0 V.

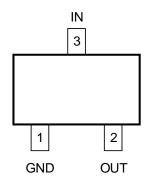
PIN CONFIGURATION (Top View)



SOT23-5 / SC70-5



DFN1.0 × 1.0-4 / UTDFN1.0 × 1.0-4



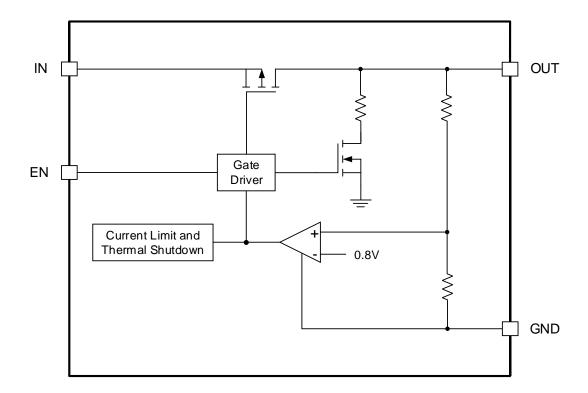
SOT23-3



PIN FUNCTION

	Pin Number		Pin	
SOT23-5	DFN1.0×1.0-4	SOT23-3	Name	Function
SC70-5	UTDFN1.0×1.0-4	30123-3	Name	
1	4	3	IN	Supply input pin. Must be closely decoupled to
1	4	3	IIN	GND with a 1µF or greater ceramic capacitor.
2	2	1	GND	Ground.
3	3		EN	Enable control input, active high. Do not leave
3	3		□IN	EN floating.
4			NC	No connection.
E	4	2	OUT	Output pin. Bypass a 1 µF ceramic capacitor
5		2	001	from this pin to ground.

BLOCK DIAGRAM



FUNCTIONAL DESCRIPTION

Input Capacitor

A 1 μ F ceramic capacitor is recommended to connect between IN and GND pins to decouple input power supply glitch and noise. The amount of the capacitance may be increased without limit. This input capacitor must be located as close as possible to the device to assure input stability and less noise. For PCB layout, a wide copper trace is required for both IN and GND.

Output Capacitor

An output capacitor is required for the stability of the LDO. The recommended output capacitance is from 1 µF



to 2.2 μ F, Equivalent Series Resistance (ESR) is from 5 m Ω to 100 m Ω , and temperature characteristics is X7R or X5R. Higher capacitance values help to improve load/line transient response. The output capacitance may be increased to keep low undershoot/overshoot. Place output capacitor as close as possible to OUT and GND pins.

ON/OFF Input Operation

The SUM33XX is turned on by setting the EN pin high, and is turned off by pulling it low. If this feature is not used, the EN pin should be tied to IN pin to keep the regulator output on at all time.

High PSRR and Low Noise

RF circuits such as LNA (low-noise amplifier), up/down-converter, mixer, PLL, VCO, and IF stage, require low noise and high PSRR LDOs. The temperature-compensated crystal oscillator circuit requires very high PSRR at RF power amplifier burst frequency. For instance, minimum 62 dB PSRR at 217 Hz is recommended for the GSM handsets.

The SUM33XX, with PSRR of 62 dB at 1 kHz, is suitable for most of these applications that require high PSRR and low noise.

Ultra Fast Start-up

After enabled, the SUM33XX is able to provide full power in as little as tens of microseconds, typically 25 μ s. This feature will help load circuitry move in and out of standby mode in real time, eventually extend battery life for mobile phones and other portable devices.

Fast Transient Response

Fast transient response LDOs can also extend battery life. To meet this load requirement, the LDO must react very quickly without a large voltage drop or overshoot — a requirement that cannot be met with conventional, general-purpose LDOs.

The SUM33XX's fast transient response from 0 to 300 mA provides stable voltage supply for fast DSP and GSM chipset with fast changing load.

Low Quiescent Current

The SUM33XX, consuming only around 40 μ A for all input range and output loading, provides great power saving in portable and low power applications.

Current Limit Protection

When output current at the OUT pin is higher than current limit threshold or the OUT pin, the current limit protection will be triggered and clamp the output current to approximately 500 mA to prevent over-current and to protect the regulator from damage due to overheating.

Thermal Shutdown Protection

Thermal protection disables the output when the junction temperature rises to approximately +155°C, allowing the device to cool down. When the junction temperature reduces to approximately +130°C the output circuitry is enabled again. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This cycling limits the heat dissipation of the regulator, protecting it from damage due to overheating.



RECOMMENDED OPERATING CONDITIONS

Symbol	Item	Rating	Unit
V_{IN}	Input Voltage	1.6 to 6.0	V
l _{OUT}	Output Current	0 to 300	mA
TA	Operating Ambient Temperature	-40 to 85	°C
Cin	Effective Input Ceramic Capacitor Value	0.47 to 4.7	μF
Соит	Effective Output Ceramic Capacitor Value	0.47 to 4.7	μF
ESR	Input and Output Capacitor Equivalent Series Resistance	5 to 100	mΩ

ABSOLUTE MAXIMUM RATINGS(2)

Parameter	Rating		Unit
IN Voltage	-0.3 to 7.0		V
Other Pin Voltage	-0.3 to V _{IN}	ı + 0.3	V
Maximum Load Current	500		mA
	SOT23-5	250	
lunction to Ambient Themsel Decistores	SC70-5	380	
Junction to Ambient Thermal Resistance $(\theta_{JA})^{(1)}$	SOT23-3	360	°C/W
(OJA),	DFN1.0 × 1.0-4	280	
	UTDFN1.0 x 1.0-4	290	
Junction Temperature	150		°C
Storage Temperature	-65 to 150		°C
Lead Temperature (Soldering, 10 sec)	300		°C

NOTE:

- (1) This particular frame decreases the total thermal resistance of the package and increases its ability to dissipate power when an appropriate area of copper on the printed circuit board is available for heat-sinking.
- (2) Stresses beyond those listed under "ABSOLUTE MAXIMUM RATINGS" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SUMSEMI recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

SUMSEMI reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time. Please contact SUMSEMI sales office to get the latest datasheet.



ELECTRICAL CHARACTERISTICS

 $(V_{IN} = V_{EN} = V_{OUT} + 1.0 \text{ V}, I_{OUT} = 1 \text{ mA}, C_{IN} = 1 \mu\text{F}, C_{OUT} = 1 \mu\text{F}, Typical values are at T_A = 25°C unless otherwise noted)$

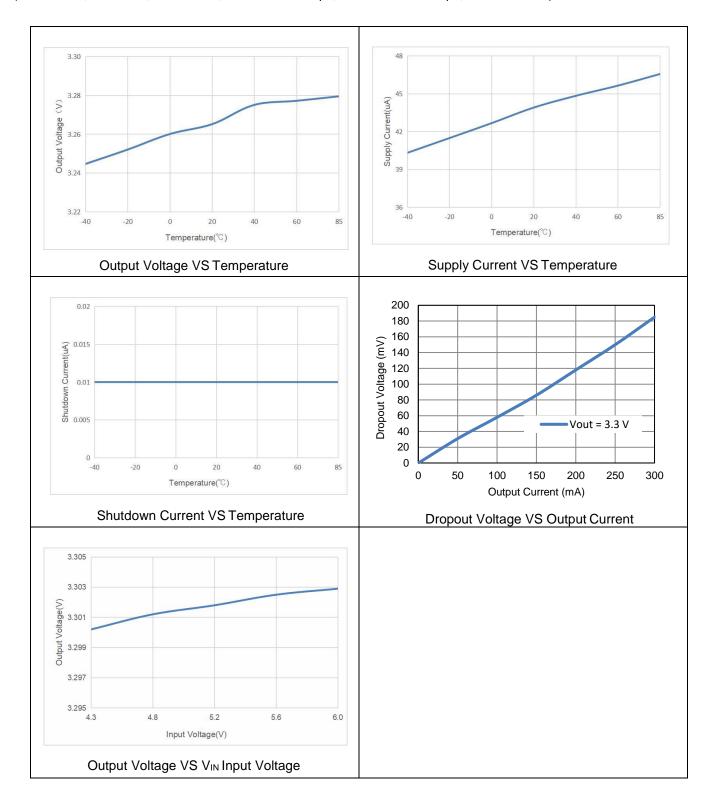
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Input Voltage Operation Range	Vin		1.6		6.0	V
Dropout Voltage		Vout = 1.8V, Iout = 300 mA		250	400	mV
Diopout voltage	V_{DROP}	$V_{OUT} = 3.3V$, $I_{OUT} = 300 \text{ mA}$		185	330	
DC Supply Quiescent Current	I_{Q_ON}	Active mode: V _{EN} = V _{IN}		40	70	μΑ
DC Supply Shutdown Current	I_{Q_OFF}	$V_{EN} = 0 V$		0.01	1	μA
Regulated Output Voltage	Vout	$I_{OUT} = 1 \text{ mA}, -40^{\circ}\text{C} \leq T_{A} \leq 85^{\circ}\text{C}$	-2		2	%
Output Voltage Line Regulation	Regline	$V_{IN} = V_{OUT} + 1 V \text{ to } 5.5 V,$ $I_{OUT} = 10 \text{ mA}$		0.03	0.2	%
Output Voltage Load Regulation	Reg _{LOAD}	I _{OUT} from 0 mA to 300 mA		20	40	mV
Soft-start Time		from Enable to Power On		25		μs
Current Limit		$R_{LOAD} = 1 \Omega$	300			mA
Dower Supply Rejection Retio	PSRR	$f=1~kHz,~C_{OUT}=1~\mu F,~I_{OUT}=20~mA$		62		dB
Power Supply Rejection Ratio	PORK	$f = 10 \text{ kHz}, C_{\text{OUT}} = 1 \mu\text{F}, I_{\text{OUT}} = 20 \text{ mA}$		60		иь
Output Noise	ем	10 Hz to100 kHz, $I_{OUT} = 100$ mA, $V_{OUT} = 2.8$ V, $C_{OUT} = 1$ μ F		60		μV _{RMS}
Soft-start Time	Ton	From Enable to Power On		25		μs
EN Low Threshold					0.4	V
EN High Threshold			1.0			V
EN pull-down resistance	R_{PD}		0.8	1	1.3	МΩ
Over-temperature Shutdown Threshold				155		°C
Over-temperature Shutdown Hysteresis				20		°C

Note: Production test at + 25°C. Specifications over the temperature range are guaranteed by design and characterization.



TYPICAL PERFORMANCE CURVES

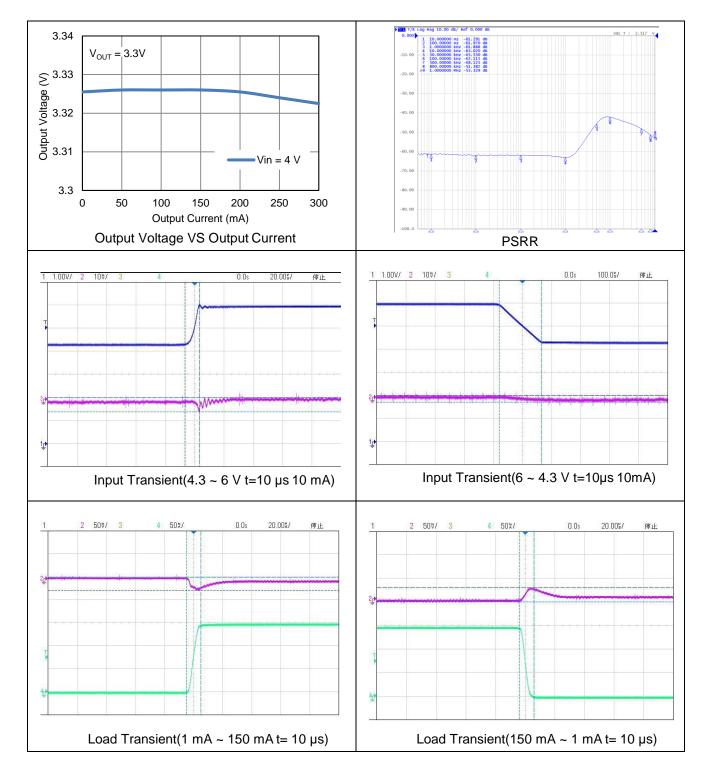
 $(V_{OUT} = 3.3 \text{ V}, V_{IN} = 4.3 \text{ V}, I_{OUT} = 1 \text{ mA}, C_{IN} = Ceramic 1.0 \mu F, C_{OUT} = Ceramic 1.0 \mu F, T_{A} = -40 ^{\circ} C \sim 85 ^{\circ} C)$





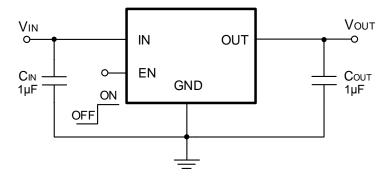
TYPICAL PERFORMANCE CURVES

 $(V_{OUT} = 3.3 \text{ V}, V_{IN} = 4.3 \text{ V}, I_{OUT} = 1 \text{ mA}, C_{IN} = Ceramic 1.0 \mu F, C_{OUT} = Ceramic 1.0 \mu F, T_{A} = -40 ^{\circ} C - 85 ^{\circ} C)$



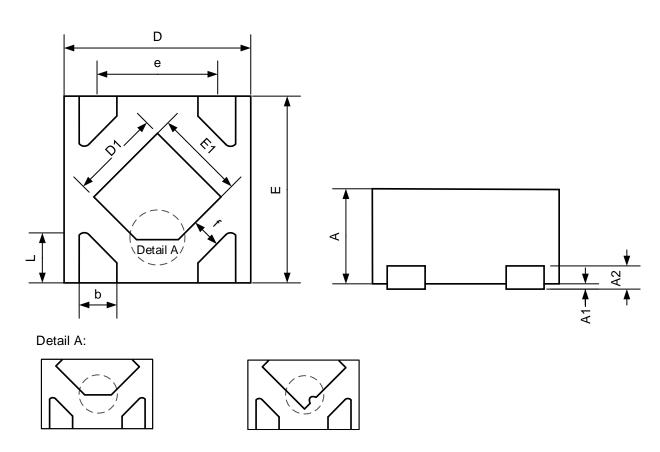


APPLICATION CIRCUITS





UTDFN1.0 × 1.0-4

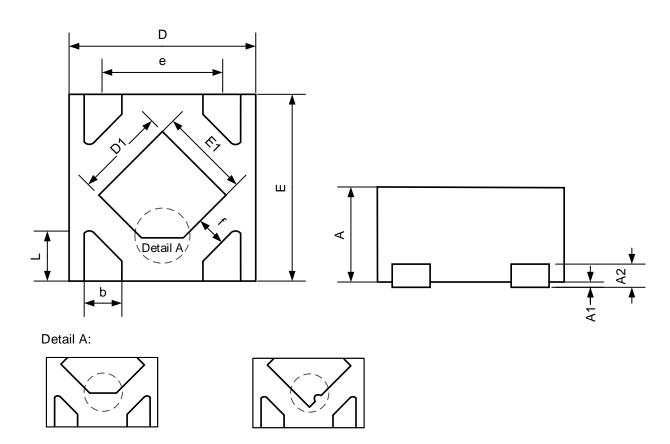


Note: Detail A has two kinds of shapes

0	Dimensions In Millimeters				
Symbol	MIN	MOD	MAX		
A	0.370	0.400	0.430		
A1	0.000	0.020	0.050		
A2		0.100REF			
D	0.950	1.000	1.050		
D1	0.430	0.480	0.530		
E	0.950	1.000	1.050		
E1	0.430	0.480	0.530		
b	0.170	0.220	0.270		
е	0.650BSC				
f	0.190	0.195	0.200		
L	0.200	0.250	0.300		



DFN1.0 × 1.0-4



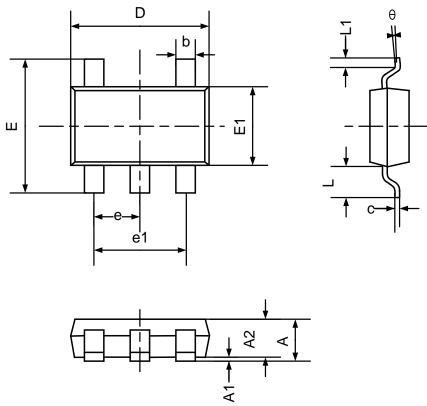
Note: Detail A has two kinds of shapes

0	Dimensions In Millimeters				
Symbol	MIN	MOD	MAX		
A	0.400	0.500	0.550		
A1	0.000	0.025	0.050		
A2		0.125REF			
D	0.950	1.000	1.050		
D1	0.380	0.480	0.580		
E	0.950	1.000	1.050		
E1	0.380	0.480	0.580		
b	0.150	0.200	0.250		
е	0.650BSC				
f	0.190	0.195	0.200		
L	0.150	0.250	0.350		

11



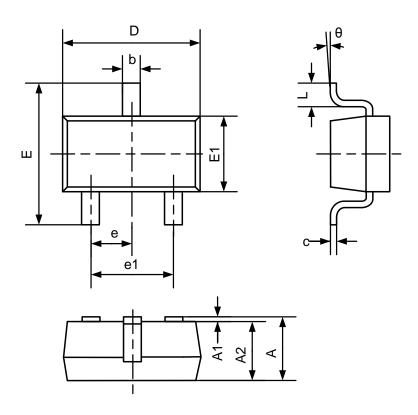
SC70-5



	Dimensions In Millimeters			
Symbol	MIN	MAX		
А	0.900	1.100		
A1	0.000	0.100		
A2	0.900	1.000		
b	0.150	0.350		
С	0.080	0.150		
D	2.000	2.200		
Е	2.150	2.450		
E1	1.150	1.350		
е	0.650BSC			
e1	1.200	1.400		
L	0.525REF			
L1	0.260	0.460		
θ	0°	8°		



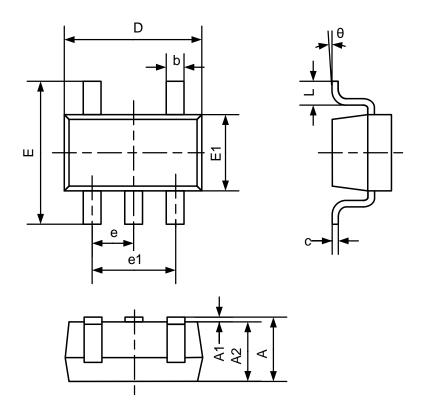
SOT23-3



	Dimensions	In Millimeters
Symbol	MIN	MAX
A	1.050	1.250
A1	0.000	0.100
A2	1.000	1.150
b	0.300	0.400
С	0.100	0.200
D	2.820	3.020
E	2.650	2.950
E1	1.500	1.700
е	0.950	OBSC
e1	1.800	2.000
L	0.300	0.600
θ	0°	8°



SOT23-5



0 1 1	Dimensions I	n Millimeters
Symbol	MIN	MAX
A	0.700	1.250
A1	0.000	0.100
A2	0.700	1.150
b	0.350	0.500
С	0.080	0.200
D	2.820	3.020
E	2.650	2.950
E1	1.500	1.700
е	0.950	BSC
e1	1.800	2.000
L	0.300	0.600
θ	0°	8°